

# ULTRA MINIATURE RELAY 2 POLES - 2 A (Slim Profile Signal Relay)

# FTR-B4 Series

## **■ FEATURES**

• DPDT 2C

 Ultra miniature slim type relay for surface mounting Height: 9.3 mm maximum (THT)
 10 mm maximum (SMT)

Weight: Approximately 1.0 g

 Conforms to Bellcore & FCC part 68, and Telcordia & FCC part 68

 Conforms to UL1950 / CSA 950, IEC 950 / EN60950 spacing and high breakdown voltage

Clearance: 1.0mm Creepage: 1.6mm

Basic insulation, 150V working voltage, pollution degree 2

• High reliable birfuracted gold overlay silver contact

• Low power consumption 140 mW (standard), 100 mW (latching)

• RoHS compliant.

Please see page 9 for more information



## PARTNUMBER INFORMATION

(a)	Relay type	FTR-B4	: FTR-B4-Series
(b)	Terminal type	C G S	: Through hole : Surface mount : Surface mount, space saving
(c)	Coil type	A B	: Standard type : Latching type (1 coil)
(d)	Coil rated voltage	4.5	: 1.524 VDC Coil rating table at page 3
(e)	Contact material	Z P	: Gold overlay silver nickel (standard) : Gold overlay silver palladium
(f)	Relay enclosing direction *1	В	: Standard enclosing direction
(g)	Number of relays per reel *2	05	: 500 (standard)

Remarks: Actual marking on relay would not carry code FTR and be as below: Ordering code: FTR-B4CA4.5Z Actual marking: B4CA4.5Z

<sup>\*1 -</sup> Only surface mount types (G and S) are applicable

<sup>\*2 -</sup> All relays are packaged in tubes unless part number ends with -B05

# ■ SPECIFICATION

Item			Standard type	Latching type		
			FTR-B4 ( ) A	FTR-B4 ( ) B		
Contact Data	Configuration		2 form C			
	Construction		Bifurcated contacts (cross-	Bifurcated contacts (cross-bar)		
	Material		Gold overlay silver nickel / Gold overlay silver palladium			
	Resistance (Initial)		Max. 100 mΩ at 1 A, 6 VD0	<u>'</u>		
	Contact rating (resistiv	re)	30VDC, 1A / 125VAC, 0.3A			
	Max. carrying current		2A			
	Max. switching voltage	و	250 VAC / 220VDC			
	Max. switching power		62.5VA / 30W			
	Min. switching load *		0.01mA, 10mVDC			
Life	Mechanical		Min. 50 x 10 <sup>6</sup> operations	Min. 20 x 10 <sup>6</sup> operations		
	Electrical	DC load	Min. 100 x 10 <sup>3</sup> operations	at 1A, 30VDC (at 0.5 Hz)		
	Electrical	AC load	Min. 100 x 10 <sup>3</sup> operations	at 0.3A, 125VAC (at 0.5 Hz)		
Coil Data	Rated power		140mW - 230mW	100mW - 130mW		
	Operate power		80mW - 130mW	57mW - 68mW		
	Operating temperature	e range	-40 °C to +85 °C (no frost)			
Timing Data	Operate (at nominal v	oltage, no bounce)	Max. 3 ms	Max. 3 ms (set)		
	Release (at nominal vo	oltage, no bounce)	Max. 3 ms	Max. 3 ms (reset)		
Insulation	Resistance (initial)		Min. 1,000MΩ at 500VDC			
	Dielectric strength	Open contacts	1,000VAC (50/60Hz) 1min			
		Contacts to coil	1,500VAC (50/60Hz) 1min			
		Adjacent contacts	1,000VAC (50/60Hz) 1min.			
	Surge strength	Coil to contacts	2,500V, 2 x 10µs standard wave			
		Adjacent contacts	1.0 mm			
	Clearance	Open contacts	0.28 mm			
		Coil and contacts	1.0 mm			
		Adjacent contacts	1.0 mm			
	Creepage	Open contacts	0.28 mm			
		Coil and contacts	1.60 mm			
Other	Vibration resistance	Misoperation	10 to 55 Hz at double amplitude of 3 mm			
	VIDIGUOII TESISLATICE	Endurance	10 to 55 Hz at double amplitude of 5 mm			
	Shock	Misoperation	750m/s <sup>2</sup>			
	SHOCK	Endurance	1,000m/s <sup>2</sup>			
	Weight		Approximately 1 g			

<sup>\*</sup> Minimum switching loads mentioned above are reference values. Please perform the confirmation test with actual load before production since reference values may vary according to switching frequencies, environmental conditions and expected reliability levels.

## **COIL RATING**

## Standard type

Coil Code	Rated Coil Voltage (VDC)	Coil Resistance +/- 10% (Ohm)	Must Operate Voltage (VDC) *	Must Release Voltage (VDC) *	Max. Coil Voltage (VDC)	Rated Power (mW)
1.5	1.5	16.1	1.13	0.15	3.53	
003	3	64.3	2.25	0.3	7.05	
4.5	4.5	145	3.38	0.45	10.58	140
006	6	257	4.5	0.6	14.10	
009	9	579	6.75	0.9	21.15	
012	12	1,028	9	1.2	28.20	
024	24	2,504	18	2.4	56.40	230

# Latching type (1 coil)

Coil Code	Rated Coil Voltage (VDC)	Coil Resis- tance +/- 10% (Ohm)	Must Operate Voltage (VDC) *	Must Release Voltage (VDC) *	Max. Coil Voltage (VDC)	Set/Re-set current (mA)	Rated Power (mW)
1.5	1.5	22.5	1.13	-0.13	3.53	50	
003	3	90	2.25	-2.25	7.05	25	
4.5	4.5	203	3.38	-3.38	10.58	17	100
006	6	360	4.5	-4.5	14.10	13	
009	9	810	6.75	-6.75	21.15	8	
012	12	1,440	9	-9	28.20	6	
024	24	4,800	18	-18	56.40	4	120

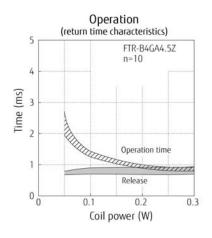
Note: All values in the table are valid for 20°C and zero contact current. \* Specified operate values are valid for pulse wave voltage.

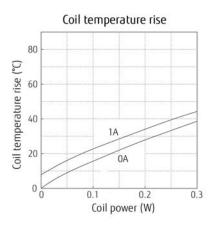
# **SAFETY STANDARDS**

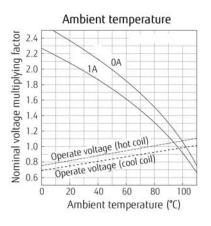
Туре	Compliance	Contact rating
UL	UL 508	Flammability: UL 94-V0 (plastics)
	E 63615	0.5A, 125VAC (resistive) 1A, 30VDC (resistive)
CSA	C22.2 No. 14 LR 40304	0.3A, 110VDC (resistive) 2A, 30VDC (resistive)

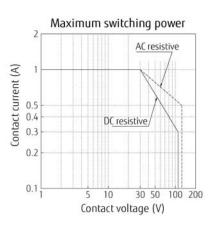
## ■ CHARACTERISTIC DATA

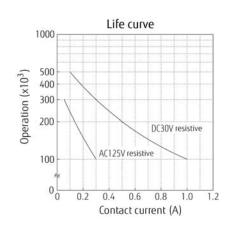
#### Standard type

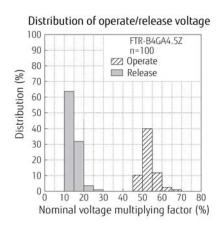


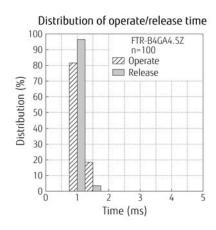


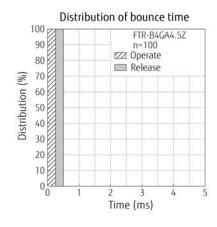


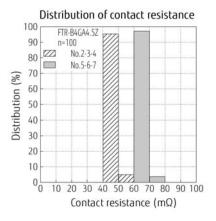


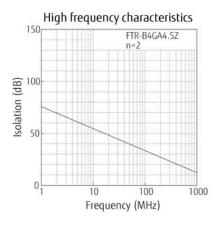


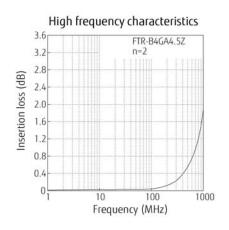




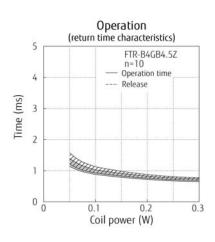


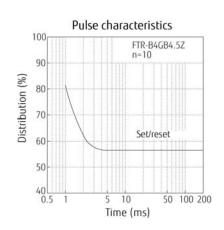


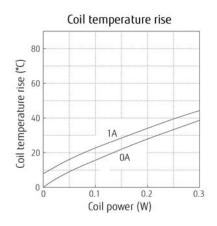


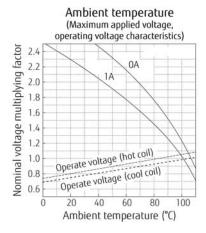


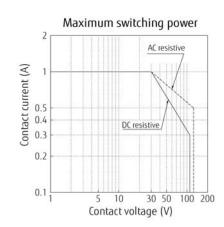
## • Latching type (1coil)

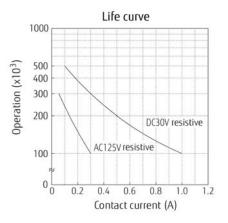


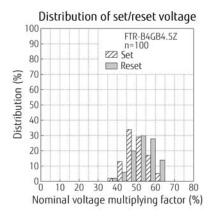


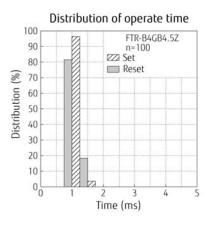


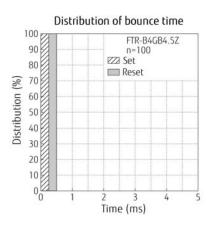


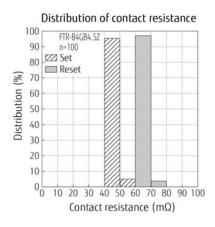


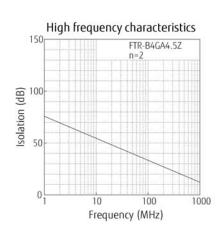


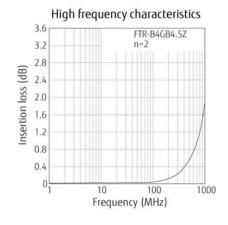








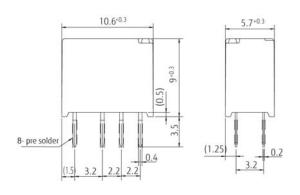




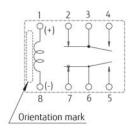
## DIMENSIONS

FTR-B4C - Through hole type

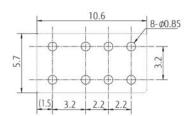
Dimensions



• Schematics (BOTTOM VIEW)

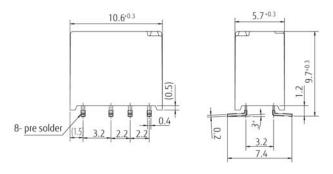


 PC board mounting hole layout (BOTTOM VIEW)

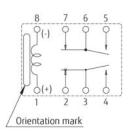


FTR-B4G - Surface mount type

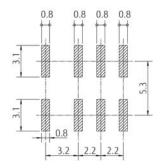
Dimensions



 Schematics (TOP VIEW)

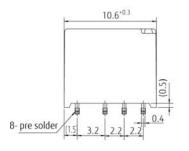


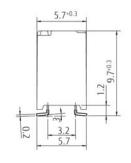
 PC board mounting pad layout (TOP VIEW)



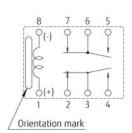
FTR-B4S- Space saving type

Dimensions

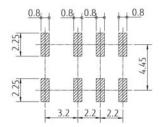




Schematics (TOP VIEW)



 PC board mounting pad layout (TOP VIEW)



# ■ RECOMMENDED SOLDERING CONDITIONS FOR SMT (SEE PAGE 9) (TEMPERATURE PROFILE)

#### Notes:

1. Temperature profiles on page 9 show the temperature of PC board surface.

2. Please perform soldering test with your actual PC board before mass production, since the temperatures of PC board surfaces vary according to the size of PC board, status of parts mounting and heating method.

#### PRECAUTIONS

- For details on general precautions, refer to the section on technical descriptions.

- Since this is a polarized relay, follow the instructions of the internal wiring diagram for the  $\pm$  connections of the coil.

- Note that the terminal layout and internal wiring of the surface mount relay are a top view.

- SMT versions of the FTR-B4 relays have moisture sensitivity level 3, acc. JEDEC-J-STD-020D

- SMT versions of the FTR-B4 relays will be shipped in "dry pack". Relays have an "out of bag" storage time of 192h.

#### PACKAGING SPECIFICATIONS

#### Packaging method

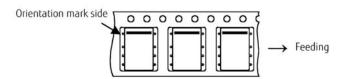
- Packaging standard: JIS C 0806

- Taping type: TB 2412

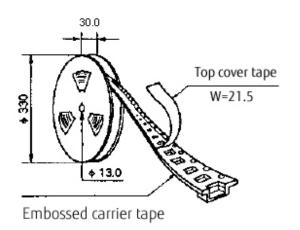
- Reel type: R24D

- Quantity of 1 reel: 500 pieces

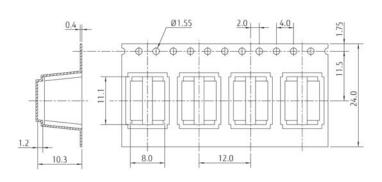
## Packaging orientation code: B



#### Reel dimensions



#### Tape dimensions



#### Note:

Relays are sold in 500 pieces per box. Minimum order quantity is 1000 pieces for tube packing and 500 pieces for tape & reel packing.

# **RoHS Compliance and Lead Free Information**

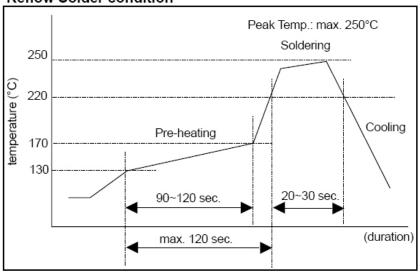
## 1. General Information

- All signal and power relays produced by Fujitsu Components are compliant with RoHS directive 2002/95EC including amendments.
- Cadmium as used in electrical contacts is exempted from the RoHS directives on October 21st, 2005.
   (Amendment to Directive 2002/95/EC)
- All of our signal and power relays are lead-free. Please refer to Lead-Free Status Info for older date codes at: http://www.fujitsu.com/us/downloads/MICRO/fcai/relays/lead-free-letter.pdf
- Lead free solder plating on relay terminals is Sn-3.0Cu-Ni for FTR-B3 and FTR-B4 series relays. This material has been verified to be compatible with PbSn assembly process.

# 2. Recommended Lead Free Solder Profile

• Recommended solder Sn-3.0Ag-0.5Cu or Sn-3.0 Cu-Ni (only FTR-B3 and FTR-B4)





## Flow Solder condition:

Pre-heating: maximum 120°C Soldering: dip within 5 sec. at 260°C solder bath

# Solder by Soldering Iron:

Soldering Iron

Temperature: maximum 360°C Duration: maximum 3 sec.

We highly recommend that you confirm your actual solder conditions

# 3. Moisture Sensitivity

• Moisture Sensitivity Level standard is not applicable to electromechanical relays, unless otherwise indicated.

## 4. Tin Whiskers

• Dipped SnAgCu solder is known as presenting a low risk to tin whisker development. No considerable length whisker was found by our in house test.

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